MN101C57C, MN101C57D

Туре	MN101C57C	MN101C57D	MN101CF57D			
Internal ROM type	Mask	FLASH				
ROM (byte)	48K	64K				
RAM (byte)	2К					
Package (Lead-free)	QFP100-P-1818B					
	0.1 µs (at 4.5 V to 5.5 V, 20 MHz)					
Minimum Instruction	0.25 µs (at 2.7 V to 5.5 V, 8 MHz)					
Execution Time	62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*					
	* The lower limit for operation guarantee for flash memory built-in type is 2.5 V.					

Interrupts

RESET, Watchdog, External 0 to 3, External 4 (key interrupt selectable), External 5 (key interrupt dedicated), External 6, External 7, Remote control, Timer 0 to 3, Timer 6, Timer 7 (2 systems), Timer 8 (2 systems), Time base, Serial 0 (2 systems), Serial 2, A/D conversion finish

Timer Counter

Timer counter 0 : 8-bit × 1

(square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement) (square-wave/PWM output to large current terminal P50 possible)

Clock source...... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 0

Timer counter 1 : 8-bit × 1 (square-wave output, event count, synchronous output event)

1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 1

Timer counter 0, 1 can be cascade-connected.

Timer counter 2 : 8-bit \times 1

(square-wave output, additional pulse type 10-bit PWM output, event count, synchronous output event, simple pulse width measurement)

(square-wave/PWM output to large current terminal P52 possible)

Clock source...... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source coincidence with compare register 2

Timer counter 3 : 8-bit × 1

(square-wave output, event count, generation of remote control carrier, serial 0 baud rate timer) Clock source...... 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input Interrupt source coincidence with compare register 3 Timer counter 2, 3 can be cascade-connected. Timer counter 6 : 8-bit freerun timer Clock source...... 1/1 of system clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock frequency; 1/1, 1/4096, 1/8192 of XI oscillation clock frequency Interrupt source coincidence with compare register 6 Timer counter 7 : 16-bit × 1 (square-wave output, IGBT/16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture) (square-wave/PWM output to large current terminal P51 possible)

1/2, 1/4, 1/16 of external clock input frequency

Interrupt source coincidence with compare register 7 (2 lines)

MN101C57C, MN101C57D

Timer counter 8 : 16 bit \times 1 (square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, input capture) (square-wave/PWM output to large current terminal P53 possible) Clock source...... 1/1, 1/2, 1/4, 1/16, 1/128 of system clock frequency; 1/1, 1/2, 1/4, 1/16, 1/128 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency Interrupt source coincidence with compare register 8 (2 lines) Timer counters 7, 8 can be cascade-connected. (square-wave output, PWM, input capture, pulse width measurement is possible as a 32-bit timer.) Time base timer (one-minute count setting) Watchdog timer Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency Serial interface Serial 0 : synchronous type/UART (full-duplex) × 1 Clock source...... 1/2, 1/4 of system clock frequency; 1/2 of pulse output of timer counter 3 frequency ; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency Serial 2 : synchronous type × 1 of OSC oscillation clock frequency Remote Contorol Interface Remote control output : timer 0 and 3 output : the remote control carrier output of 1/2 and 1/3 duty. Remote control reception : correspondence with low speed clock waiting Correspondence with AEHA (Association for Electric Home Appliances) format (selection of a formart is available by the set-up)

■ I/O Pins

I/O	77	Common use, Specified pull-up resistor available, Input/output selectable (bit unit)
Input	6	Common use, Specified pull-up resistor available

A/D converter

10-bit \times 16-ch. (with S/H)

Display control function

LCD

47 segments \times 4 commons (static, 1/2, 1/3, or 1/4 duty)

LCD power supply separated from VDD (usable if VLCD \leq VDD)

LCD power shunt resistance contained

Special Ports

Buzzer output, remote control carrier signal output, high-current drive port

Electrical Charactreistics (Supply current)

Parameter	Symbol	Condition	Limit			Unit
		Condition		typ	max	Unit
Operating supply current	IDD1	fosc = 20 MHz, $VDD = 5 V$		15	30	mA
	IDD2	fosc = 8 MHz, $VDD = 5 V$		8	16	mA
	IDD3	fx = 32 kHz, $VDD = 3 V$		30	60 (70)	μΑ
Supply current at HALT	IDD4	fx = 32 kHz , VDD = 3 V, Ta = 25°C		4	8	μΑ
	IDD5	fx = 32 kHz , VDD = 3 V , Ta = -40° C to $+85^{\circ}$ C			30	μΑ
Supply current at STOP	IDD6	$VDD = 5 V$, $Ta = 25^{\circ}C$			2	μΑ
	IDD7	$VDD = 5 V$, $Ta = -40^{\circ}C$ to $+85^{\circ}C$			50	μΑ

(): Flash memory built-in type

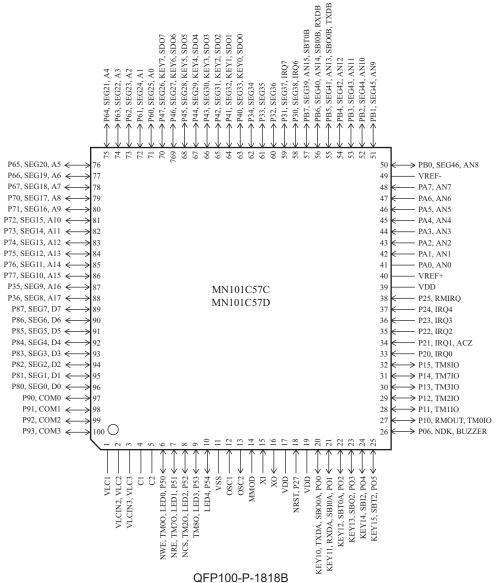
Panasonic

Development tools

In-circuit Emulator

PX-ICE101C/D+PX-PRB101C57-QFP100-P-1818B-M

Pin Assignment



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